

Feature

- **N-Channel**

$V_{DD}=40V, I_D=20A$

$R_{DS\ (ON)} < 22m\ \Omega @ V_{GS}=10V$

$R_{DS\ (ON)} < 30m\ \Omega @ V_{GS}=4.5V$

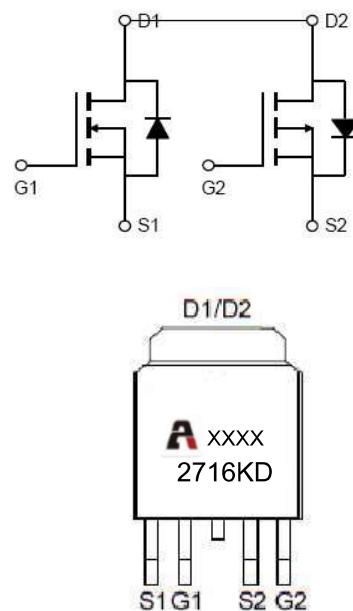
- **P-Channel**

$V_{DD}=-40V, I_D=-20A$

$R_{DS\ (ON)} < 54m\ \Omega @ V_{GS}=-10V$

$R_{DS\ (ON)} < 70m\ \Omega @ V_{GS}=-4.5V$

- Lead free product is acquired
- High power and current handing capability
- Surface mount package



Application

- PWM applications
- Load Switch
- Power management

Marking and pin assignment

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
2716KD	AP2716KD	TO-252-4		-	2500

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V_{DS}	40	-40	V
Gate-Source Voltage	V_{GS}	± 20	± 20	V
Continuous Drain Current ($T_a = 25^\circ C$)	I_D	20	-20	A
Continuous Drain Current ($T_a = 100^\circ C$)	I_D	14	-14	A
Pulsed Drain Current ⁽¹⁾	I_{DM}	60	-60	A
Power Dissipation	P_D	31.5	31.5	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	80	80	$^\circ C/W$
Junction Temperature	T_J	150	150	$^\circ C$
Storage Temperature	T_{STG}	-55~ +150	-55~ +150	$^\circ C$

N-CH ELECTRICAL CHARACTERISTICS($T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	40			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 40V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
Gate threshold voltage ⁽²⁾	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1	1.6	2.5	V
Drain-source on-resistance ⁽²⁾	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 4A$		16	22	$m\Omega$
		$V_{GS} = 4.5V, I_D = 6A$		22	30	
Dynamic characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 20V, V_{GS} = 0V, f = 1MHz$		1050		pF
Output Capacitance	C_{oss}			84		
Reverse Transfer Capacitance	C_{rss}			72		
Switching characteristics						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 20V, I_D = 5A, R_L = 6\Omega$ $V_{GS} = 10V, R_G = 1\Omega$		11		ns
Turn-on rise time	t_r			13		
Turn-off delay time	$t_{d(off)}$			36		
Turn-off fall time	t_f			9		
Total Gate Charge	Q_g	$V_{DS} = 20V, I_D = 5A,$ $V_{GS} = 10V$		11		nC
Gate-Source Charge	Q_{gs}			1.9		
Gate-Drain Charge	Q_{gd}			2.2		
Source-Drain Diode characteristics						
Diode Forward voltage ⁽²⁾	V_{DS}	$V_{GS} = 0V, I_S = 10A$			1.2	V
Diode Forward current ⁽³⁾	I_S		-	-	10	A

P-CH ELECTRICAL CHARACTERISTICS($T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-40			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = -40V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
Gate threshold voltage ⁽²⁾	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1	-1.6	-2.5	V
Drain-source on-resistance ⁽²⁾	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -10A$		44	54	$m\Omega$
		$V_{GS} = -4.5V, I_D = -6A$		55	70	
Dynamic characteristics						
Input Capacitance	C_{iss}	$V_{DS} = -20V, V_{GS} = 0V, f = 1MHz$		1160		pF
Output Capacitance	C_{oss}			155		
Reverse Transfer Capacitance	C_{rss}			98		
Switching characteristics						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -20V, I_D = -5A, R_L = 6\Omega$ $V_{GS} = -10V, R_G = 1\Omega$		8		ns
Turn-on rise time	t_r			15		
Turn-off delay time	$t_{d(off)}$			23		
Turn-off fall time	t_f			9		
Total Gate Charge	Q_g	$V_{DS} = -20V, I_D = -5A,$ $V_{GS} = -10V$		20		nC
Gate-Source Charge	Q_{gs}			3.5		
Gate-Drain Charge	Q_{gd}			4.2		
Source-Drain Diode characteristics						
Diode Forward voltage ⁽²⁾	V_{DS}	$V_{GS} = 0V, I_S = -10A$			1.2	V
Diode Forward current ⁽³⁾	I_S		-	-	-10	A

Notes:

1. Repetitive Rating: pulse width limited by maximum junction temperature
2. Pulse Test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. Surface Mounted on FR4 Board, $t \leq 10$ sec

AP2716KD

N and P-Channel Enhancement Mosfet

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DATA SHEET

N-Channel

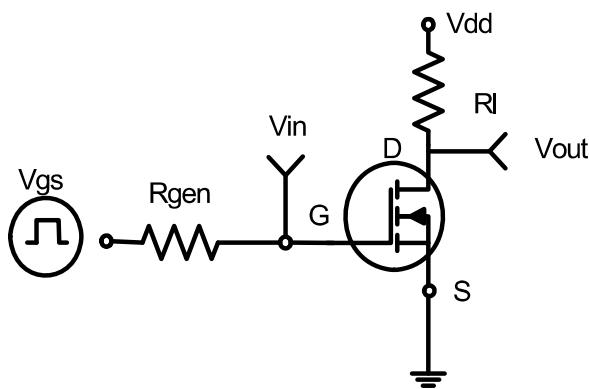


Figure 1:Switching Test Circuit

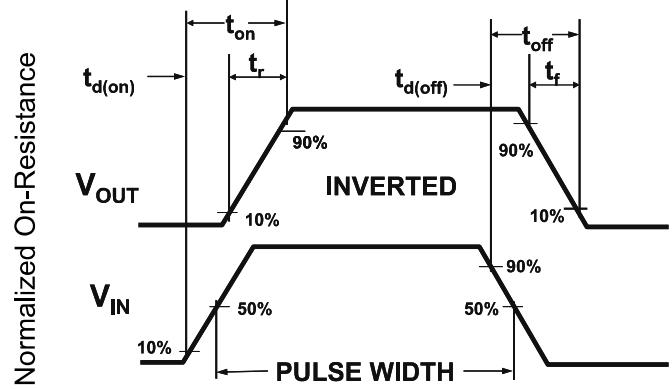


Figure 2:Switching Waveforms

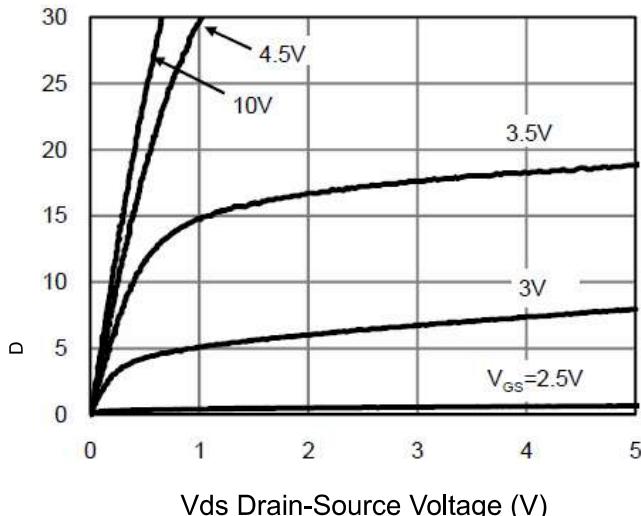


Figure 3 Output Characteristics

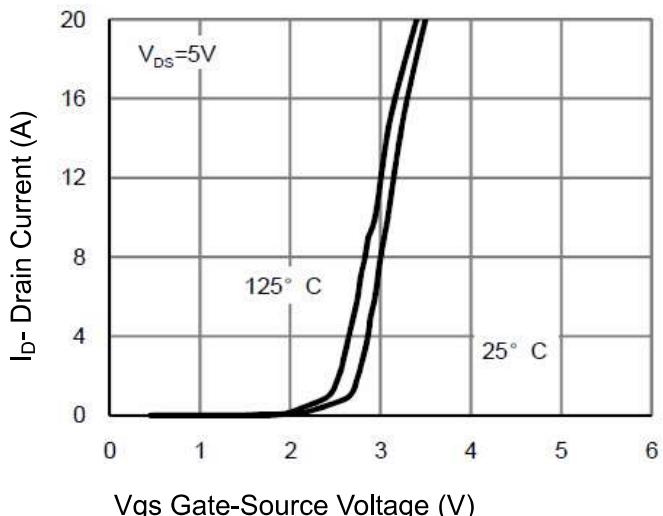


Figure 4 Transfer Characteristics

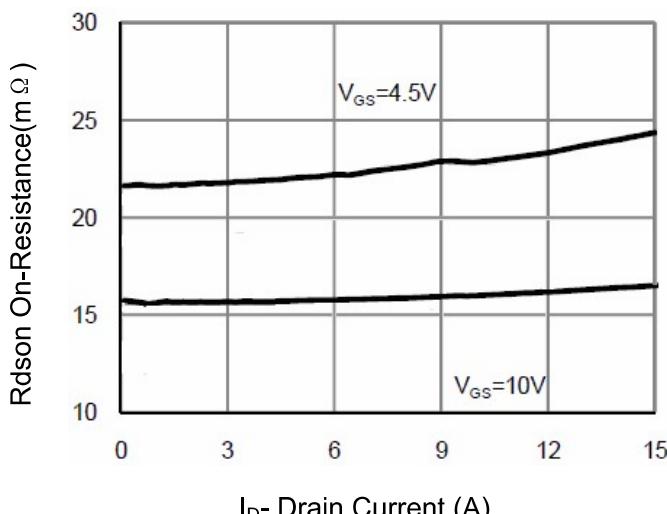


Figure 5 Drain-Source On-Resistance

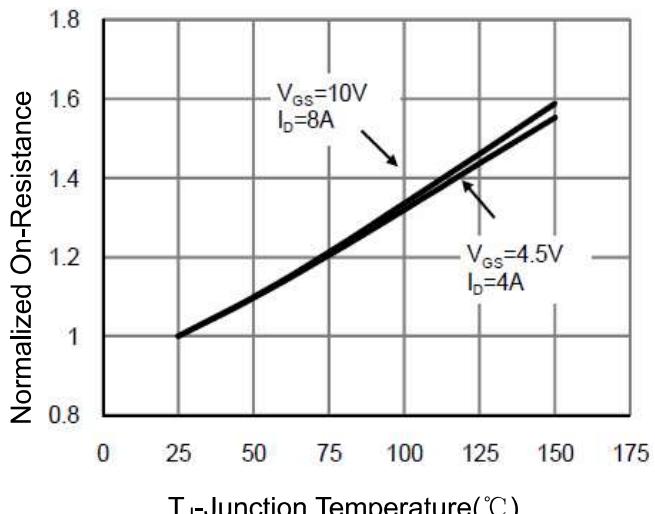
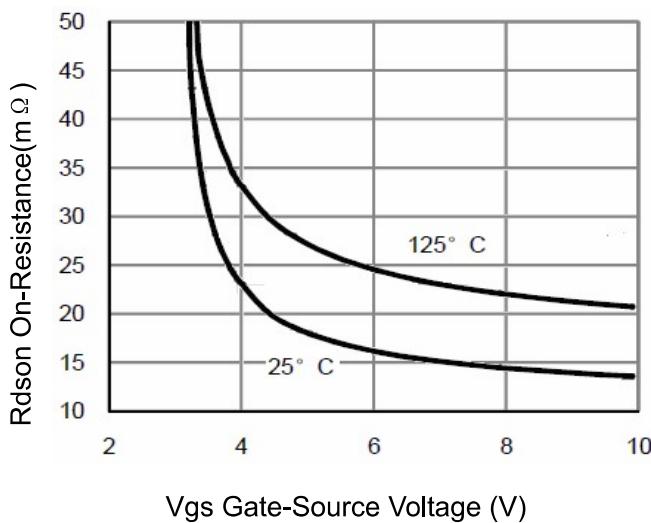


Figure 6 Drain-Source On-Resistance

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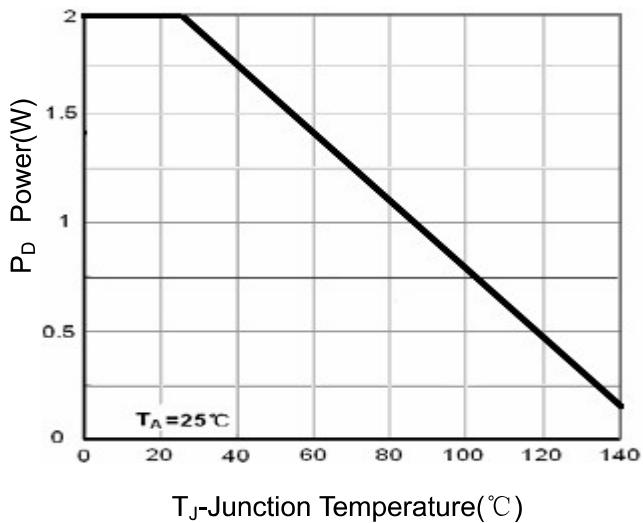
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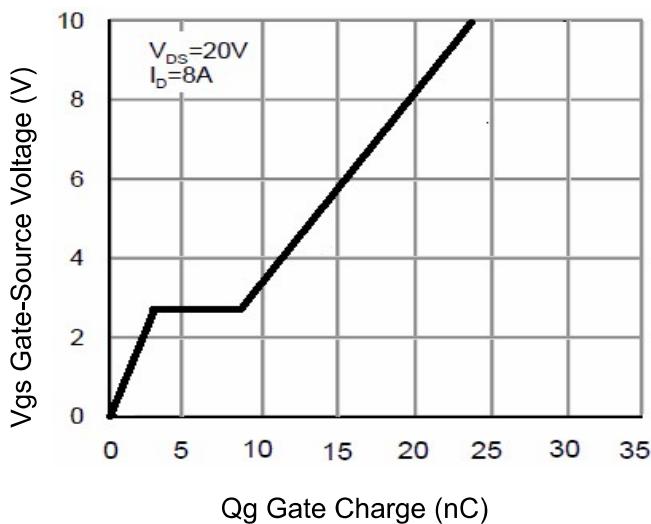
V_{GS} Gate-Source Voltage (V)

Figure 7 Rdson vs Vgs



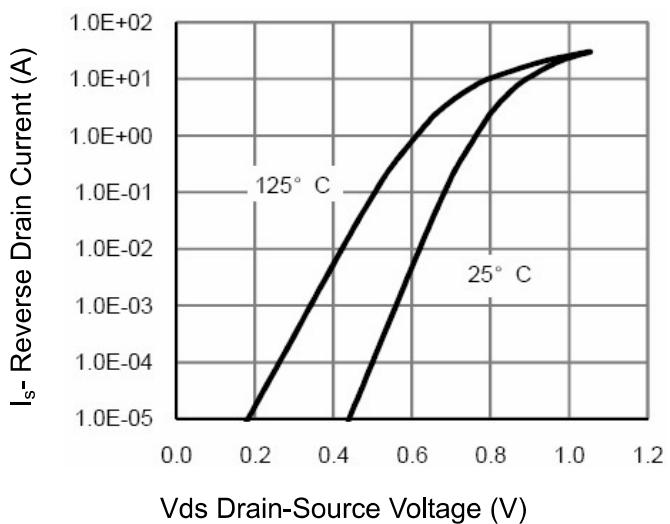
T_J-Junction Temperature(°C)

Figure 8 Power Dissipation



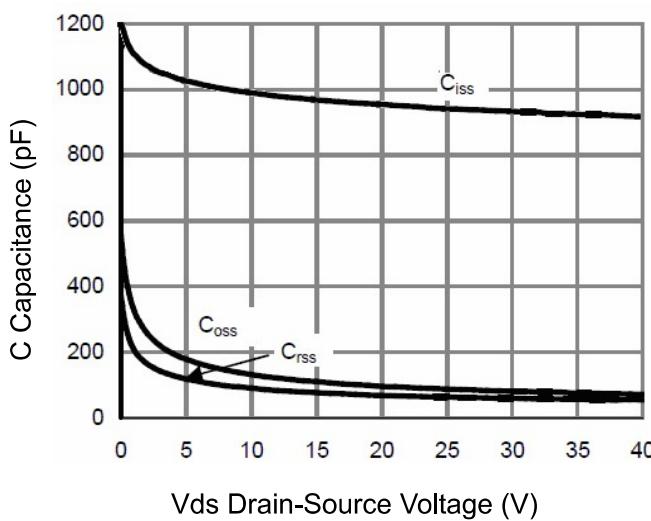
Q_g Gate Charge (nC)

Figure 9 Gate Charge



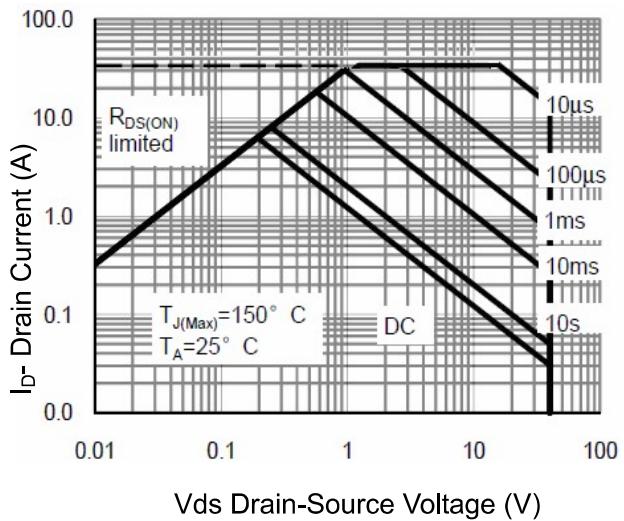
I_s-Reverse Drain Current (A)

Figure 10 Source- Drain Diode Forward



V_{DS} Drain-Source Voltage (V)

Figure 11 Capacitance vs Vds



I_D-Drain Current (A)

Figure 12 Safe Operation Area

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P-Channel

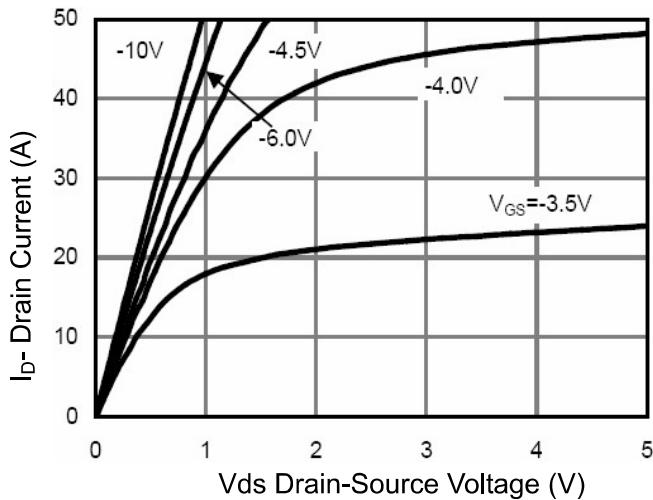


Figure 1 Output Characteristics

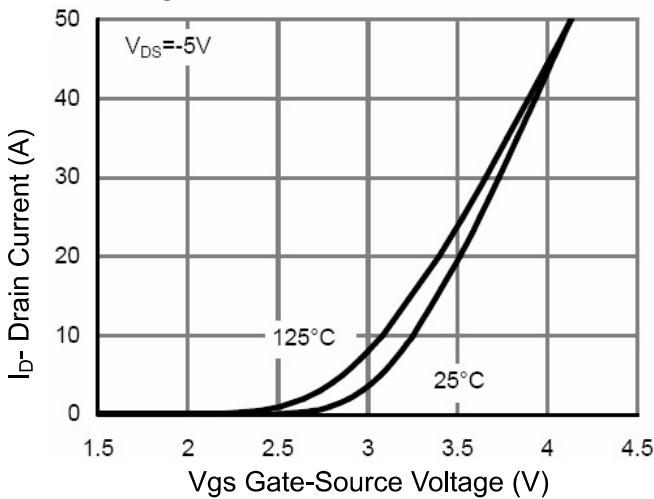


Figure 2 Transfer Characteristics

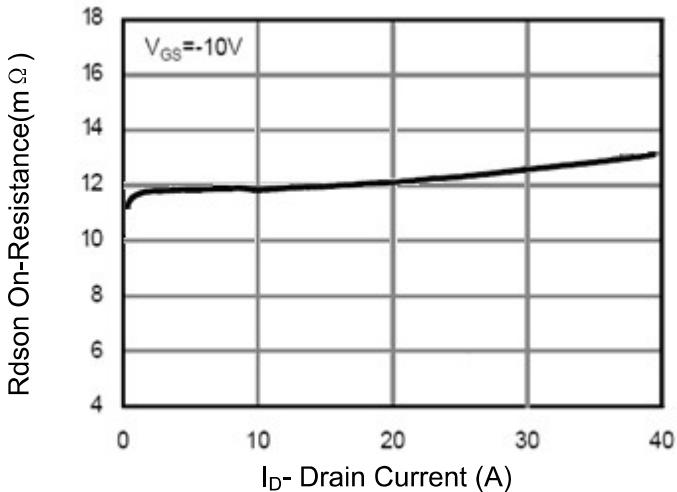


Figure 3 Rdson- Drain Current

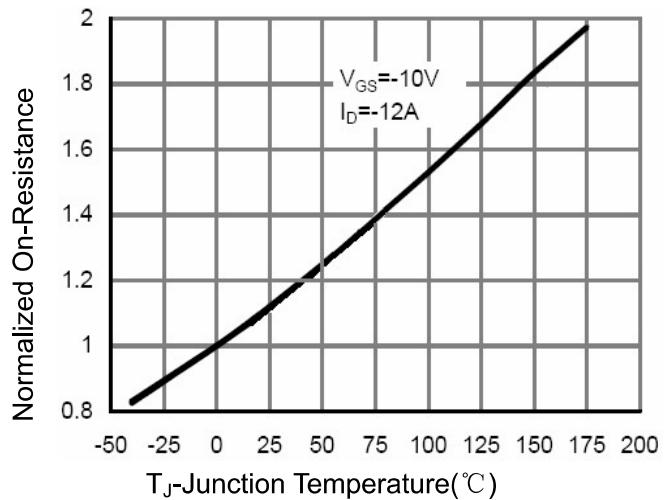


Figure 4 Rdson-Junction Temperature

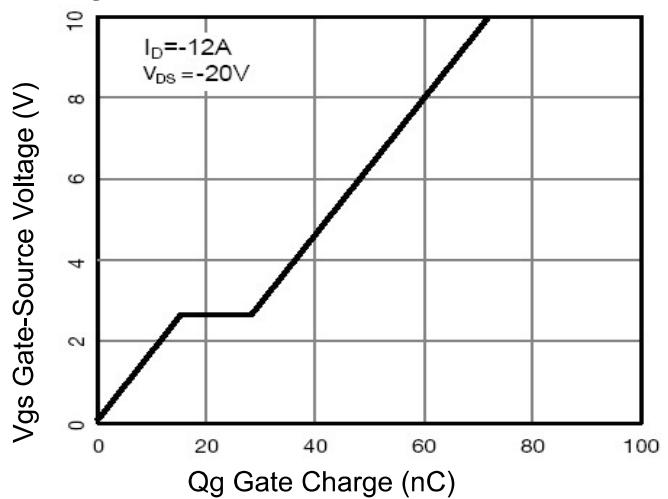


Figure 5 Gate Charge

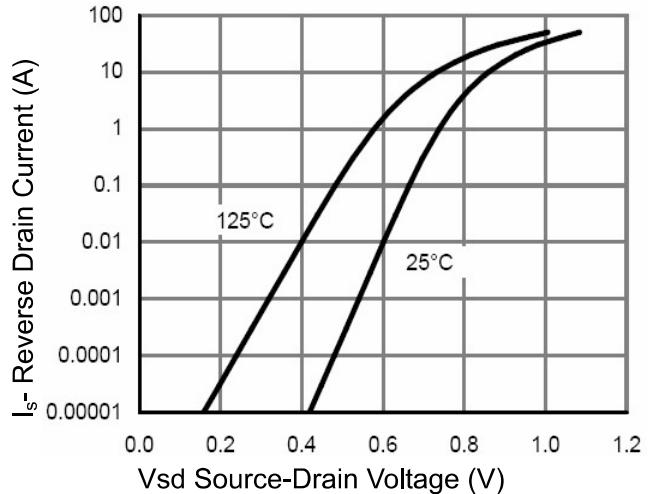
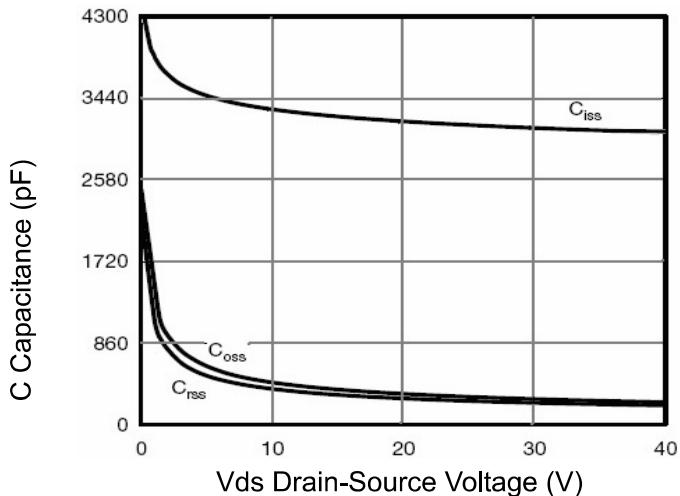
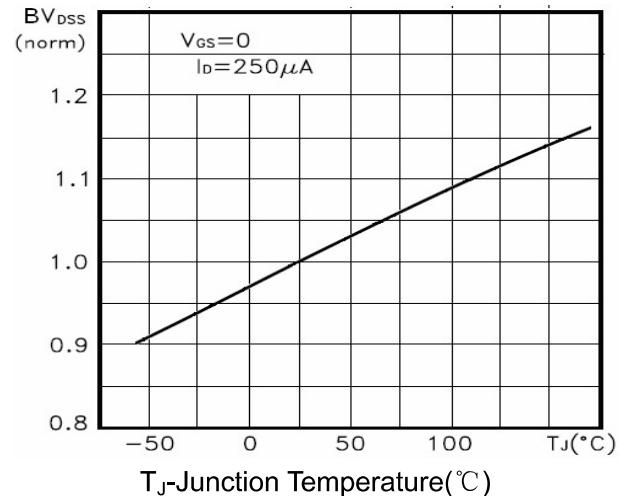
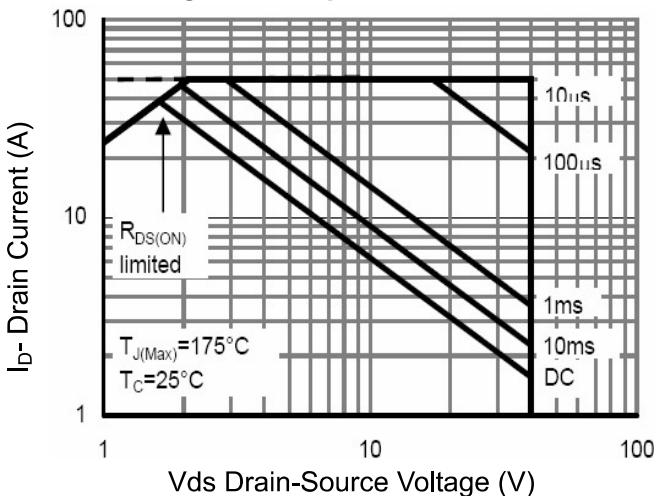
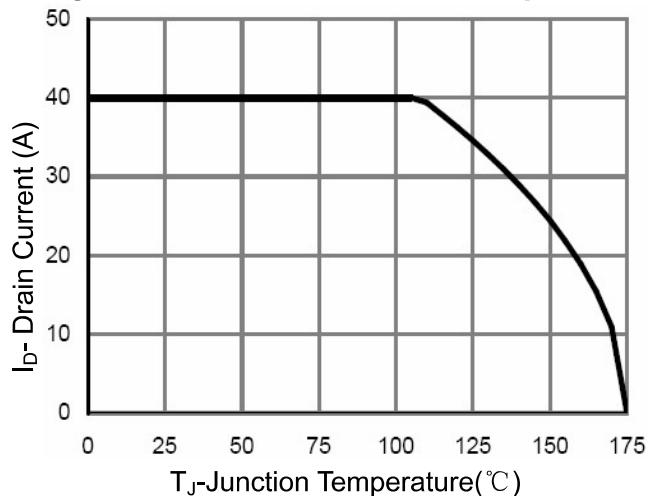
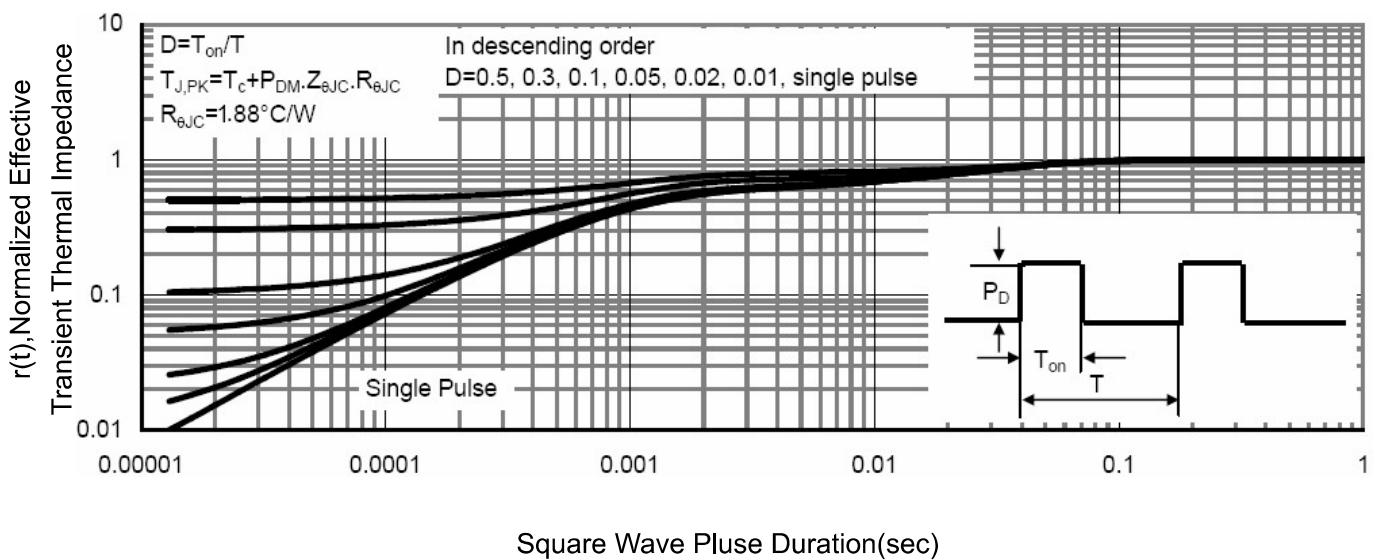
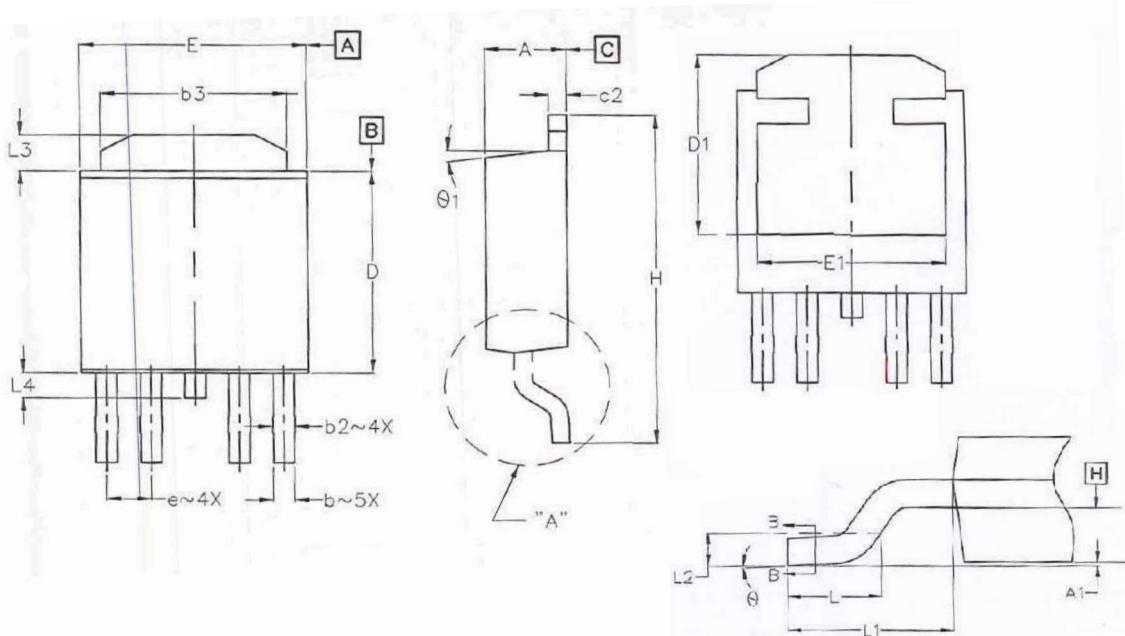


Figure 6 Source- Drain Diode Forward

**Figure 7 Capacitance vs Vds****Figure 9 BV_{DSS} vs Junction Temperature****Figure 8 Safe Operation Area****Figure 10 I_D Current Derating vs Junction Temperature****Figure 11 Normalized Maximum Transient Thermal Impedance**

TO-252-4 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.184	2.387	0.086	0.094
A1	-	0.127	-	0.094
b	0.508	0.711	0.020	0.028
b1	0.508	0.660	0.020	0.026
b2	0.610	0.787	0.024	0.031
b3	4.953	5.461	0.195	0.215
c	0.460	0.610	0.018	0.024
c1	0.410	0.559	0.016	0.022
C2	0.460	12.950	0.498	0.510
D	4.980	5.180	0.196	0.204
D1	2.650	2.950	0.104	0.116
E	7.900	8.100	0.311	0.319
E1	0.000	0.300	0.000	0.012
e	12.900	13.400	0.508	0.528
H	2.850	3.250	0.112	0.128
L	1.397	1.778	0.055	0.070
L1	2.743	BSC	0.108	BSC
L2	0.508	BSC	0.020	BSC
L3	0.889	1.270	0.035	0.050
L4	-	1.015	-	0.040
θ	0	10°	0°	10°
θ1	0	15°	0°	15°

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